

PATENT
4823-0101P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: SUNG, Ki Suk et al Conf.: Unassigned
Appl. No.: NEW Group: Unassigned
Filed: February 27, 2004 Examiner: Unassigned
For: LASER MODULE PACKAGE AND METHOD OF
MANUFACTURING THE SAME

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 27, 2004

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

This amendment includes Amendments to the Specification and Remarks.